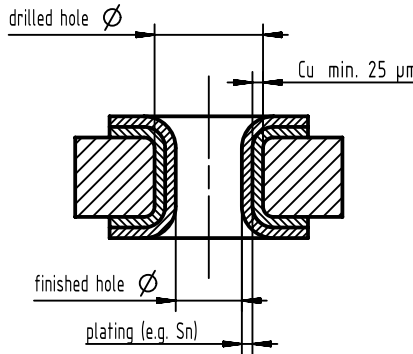
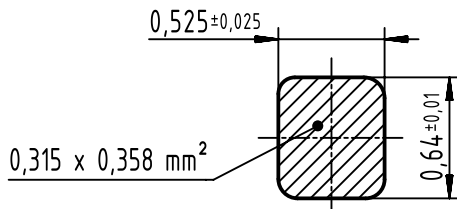
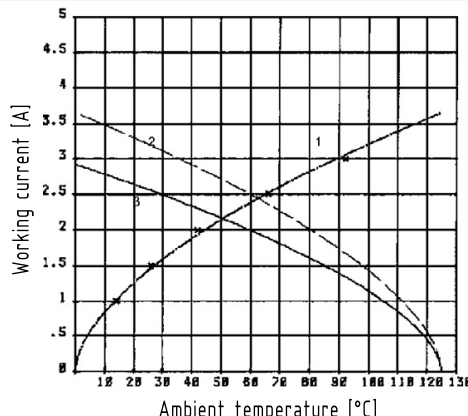


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 SEK 18 male low profile solder and press-in  RoHS compliant				Recommended configuration of plated through holes for press-in termination In addition to the hot-air-level (HAL), other PCB surfaces are getting more important. Due to their different properties – such as mechanical strength and coefficient of friction – we recommend the following configuration of PCB through holes.  <table><tr><td rowspan="3">Tin plated PCB (HAL) acc. to EN 60352-5</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>Sn</td><td>max. 15 µm</td></tr><tr><td rowspan="3">Chemical tin plated PCB</td><td>plated hole Ø</td><td>0,94 – 1,09 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td rowspan="2"></td><td>Sn</td><td>min. 0,8µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td rowspan="4">Gold /Nickel plated PCB</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>Ni</td><td>3 – 7 µm</td></tr><tr><td>Au</td><td>0,05 – 0,12 µm</td></tr><tr><td rowspan="3">Silver plated PCB</td><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td rowspan="3">Copper plated PCB (OSP)</td><td>Ag</td><td>0,1 – 0,3 µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td rowspan="3"></td><td>Cu</td><td>min. 25 µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr></table> Assembly instructions It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further information about the press-in process. Soldering instructions The connectors should be protected when being soldered in a dip, flow or film soldering baths. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating. (1) For prototypes and short runs protect the connectors with an industrial adhesive tape, e.g. Tesaband 4331 (www.tesa.de). Cover the underside of the connector moulding and the adjacent parts of the pcb as well as the open sides of the connector. This will prevent heat and gases of the soldering apparatus from damaging the connector. About 140 + 5 mm of the tape should suffice. (2) For large series a jig is recommended. Its protective cover with a fast action mechanical locking device shields the connectors from gas and heat generated by the soldering apparatus. As an additional protection a foil can be used for covering the parts that should not be soldered. Packaging material (only for plastic tray) <table><tr><td>Material</td><td>Polystyrol</td></tr><tr><td>Color</td><td>Yellow</td></tr><tr><td>Standardization</td><td>acc. to DIN EN / IEC 61340-5-1 and ANSI / ESD S541-2003</td></tr></table> - Safe protection for electronic components against electrostatic charges Cross section of solder terminations   All Dimensions in mm Original Size DIN A3  All rights reserved Department EC PD – DE HARTING Electronics GmbH D-32339 Espelkamp TypeDS Number09181100001 Scale1:1 Free size tol. Created bySTORCK Inspected byLEHNERT StandardisationHOFFMANN Date2016-09-05 StateFinal Release TitleSEK 18 male low profile solder and press-in Doc-Key / ECM-Nr. 100554984/UGD/001/F 500000107692 Rev.F Page1/1 General information <table><tr><td>Design</td><td colspan="3">IEC 60603-13</td></tr><tr><td>No. of contacts</td><td colspan="3">6,10,14,16,20,26,30,34,40,50,60,64</td></tr><tr><td>Contact spacing</td><td colspan="3">2,54 mm x 2,54 mm</td></tr><tr><td>Test voltage Ur.m.s</td><td colspan="3">1 kV</td></tr><tr><td>Working voltage</td><td colspan="3">500 V for pollution degree 1</td></tr><tr><td>Working current acc. to IEC 60512-2</td><td colspan="3">See derating diagram</td></tr><tr><td>Contact resistance</td><td colspan="3">max. 20mOhm</td></tr><tr><td>Insulation resistance</td><td colspan="3">min. 10⁹Ohm</td></tr><tr><td>Temperature range</td><td colspan="3">-55°C ... +125°C (solder) -55°C ... +105°C (press-in)</td></tr><tr><td>Termination technology</td><td colspan="3">solder, press-in</td></tr><tr><td>Clearance & creepage distance</td><td colspan="3">min. 0,5 mm clearance min. 0,56 creepage</td></tr></table> Insertion and withdrawal forces <table><tr><td>6-pole max. 12N for PL1-2 / 18N for PL3</td><td colspan="2">; 30-pole max. 60N for PL1-2 / 90N for PL3</td></tr><tr><td>10-pole max. 20N for PL1-2 / 30N for PL3</td><td colspan="2">; 34-poles max. 68N for PL1-2 / 102N for PL3</td></tr><tr><td>14-pole max. 28N for PL1-2 / 42 for PL3</td><td colspan="2">; 40-poles max. 80N for PL1-2 / 120N for PL3</td></tr><tr><td>16-pole max. 32N for PL1-2 / 48N for PL3</td><td colspan="2">; 50-poles max. 100N for PL1-2 / 150N for PL3</td></tr><tr><td>20-pole max. 40N for PL1-2 / 60N for PL3</td><td colspan="2">; 60-poles max. 120N for PL1-2 / 180N for PL3</td></tr><tr><td>26-pole max. 52N for PL1-2 / 78N for PL3</td><td colspan="2">; 64-poles max. 128N for PL1-2 / 192N for PL3</td></tr></table> Mating cycles <table><tr><td>S4 surface treatment</td><td colspan="2">Au over PdNi (min. 0,76 µm)</td></tr><tr><td>PL 1 acc. to IEC 60603-13</td><td>500 mating cycles</td><td>10 days gas test</td></tr><tr><td>PL 2 acc. to IEC 60603-13</td><td>250 mating cycles</td><td>4 days gas test</td></tr><tr><td>PL 3 acc. to IEC 60603-13</td><td>50 mating cycles</td><td>No gas test</td></tr></table> UL file <table><tr><td>UL file</td><td colspan="3">E 102079</td></tr><tr><td>RoHS – compliant</td><td colspan="3">Yes</td></tr><tr><td>Leadfree</td><td colspan="3">Yes</td></tr><tr><td>Hot plugging</td><td colspan="3">No</td></tr></table> Insulator material <table><tr><td>Material</td><td colspan="3">PBT (thermoplastics, glass fiber reinforcement 30%)</td></tr><tr><td>Color</td><td colspan="3">black (RAL 7001) or grey (RAL 7032) for solder grey (RAL 7053) for press-in</td></tr><tr><td>UL classification</td><td colspan="3">UL94-V0</td></tr><tr><td>Material group acc. 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Control and test procedures according to DIN IEC 60512. 1) Temperature rise 2) Derating 3) Derating curve at I max x 0.8(IEC 60512-2)  <tr><td>1</td><td>2</td><td>3</td><td>4</td><td>5</td><td>6</td><td>7</td><td>8</td></tr>				Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Sn	max. 15 µm	Chemical tin plated PCB	plated hole Ø	0,94 – 1,09 mm	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm		Sn	min. 0,8µm	plated hole Ø	1,00 – 1,10 mm	Gold /Nickel plated PCB	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Ni	3 – 7 µm	Au	0,05 – 0,12 µm	Silver plated PCB	plated hole Ø	1,00 – 1,10 mm	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Copper plated PCB (OSP)	Ag	0,1 – 0,3 µm	plated hole Ø	1,00 – 1,10 mm	Drilled hole Ø	1,15-0,03 mm		Cu	min. 25 µm	plated hole Ø	1,00 – 1,10 mm	Material	Polystyrol	Color	Yellow	Standardization	acc. to DIN EN / IEC 61340-5-1 and ANSI / ESD S541-2003	Design	IEC 60603-13			No. of contacts	6,10,14,16,20,26,30,34,40,50,60,64			Contact spacing	2,54 mm x 2,54 mm			Test voltage Ur.m.s	1 kV			Working voltage	500 V for pollution degree 1			Working current acc. to IEC 60512-2	See derating diagram			Contact resistance	max. 20mOhm			Insulation resistance	min. 10 ⁹ Ohm			Temperature range	-55°C ... +125°C (solder) -55°C ... +105°C (press-in)			Termination technology	solder, press-in			Clearance & creepage distance	min. 0,5 mm clearance min. 0,56 creepage			6-pole max. 12N for PL1-2 / 18N for PL3	; 30-pole max. 60N for PL1-2 / 90N for PL3		10-pole max. 20N for PL1-2 / 30N for PL3	; 34-poles max. 68N for PL1-2 / 102N for PL3		14-pole max. 28N for PL1-2 / 42 for PL3	; 40-poles max. 80N for PL1-2 / 120N for PL3		16-pole max. 32N for PL1-2 / 48N for PL3	; 50-poles max. 100N for PL1-2 / 150N for PL3		20-pole max. 40N for PL1-2 / 60N for PL3	; 60-poles max. 120N for PL1-2 / 180N for PL3		26-pole max. 52N for PL1-2 / 78N for PL3	; 64-poles max. 128N for PL1-2 / 192N for PL3		S4 surface treatment	Au over PdNi (min. 0,76 µm)		PL 1 acc. to IEC 60603-13	500 mating cycles	10 days gas test	PL 2 acc. to IEC 60603-13	250 mating cycles	4 days gas test	PL 3 acc. to IEC 60603-13	50 mating cycles	No gas test	UL file	E 102079			RoHS – compliant	Yes			Leadfree	Yes			Hot plugging	No			Material	PBT (thermoplastics, glass fiber reinforcement 30%)			Color	black (RAL 7001) or grey (RAL 7032) for solder grey (RAL 7053) for press-in			UL classification	UL94-V0			Material group acc. 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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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Как с нами связаться

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